

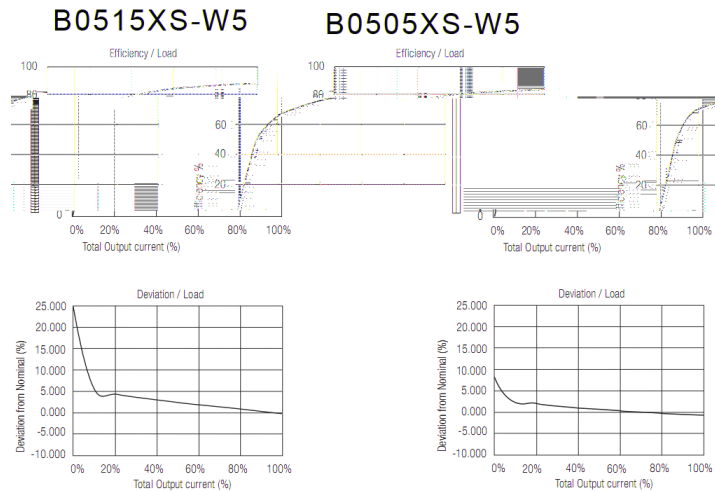
SELECTION GUIDE					
	()	()	()	(%)	
0505 - 5	5	5	100	80	470
1205 - 5	12	5	100	82	470
0512 - 5	5	12	42	83	150
1212 - 5	12	12	42	86	150
0515 - 5	5	15	33	84	150
1215 - 5	12	15	33	87	150

, . . . : 0505 - 5

S ecifica i

10%
5%
1.2%/1% ..
(10% 100%) 10% . / 4% ..
(20) 100 - .

Technical



1	62321:2008	13061091	-4	0611042	-1
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Package Seal Pict ()

Print Details

1.15/-0

Pin Connections

Pin #	Single
1	-Vin
2	+Vin
3	-Vout
4	+Vout

XX.X ± 0.5 mm

Recommended Footp

1.00 ± C

2.54

Top View



RoHS COMPLIANT INFORMATION

This series is compatible with RoHS soldering systems with a peak wave solder temperature of 300°C for 10 seconds. The pin termination finish on the SIP package type is Tin Plate, Hot Dipped over Matte Tin with Nickel Preplate. The DIP types are Matte Tin over Nickel Preplate. Both types in this series are backward compatible with Sn/Pb soldering systems.



REACH COMPLIANT INFORMATION

This series has proven that this product does not contain harmful chemicals, it also has harmful chemical substances through the registration, inspection and approval.